Attachment no 2

[place […………•], [date] [………………•]

|  |
| --- |
| **Contractor:**  [Name / address / registry court / KRS [National Court Register]number / NIP [Tax ID]/ contact person / e-mail address / telephone number] |

* Contracting Party: VIGO System Spółka Akcyjna, Joint-Stock Company with its registered office in Ożarów Mazowiecki, ul. Poznańska 129/133, 05-850 Ożarów Mazowiecki, entered into the Register of Entrepreneurs of the National Court Register kept by the District Court for the Capital City of Warsaw in Warsaw, 14th Commercial Division of the National Court Register, KRS (National Court Register) No. 0000113394,  
  NIP (Tax ID): 5270207340, REGON (Statistical Register Number): 010265179, with the share capital ofPLN 729,000.00 (paid up in full)

**SPECIMEN OF PROPOSAL FORM   
FOR THE REQUEST FOR PROPOSAL of 12th November 2021  
 NUMBER IGA-11\_21**

I, the undersigned ………………………………[•], entitled to represent the Contractor in accordance with the attached documentation (hereinafter: "Contractor"), in response to the inquiry of 12th November 2021 No. IGA-11\_21 (hereinafter: "Inquiry"), hereby submit an offer for semiconductor wafers (hereinafter: "Order") for comprehensive implementation by VIGO System Spółka Akcyjna with its registered office in Ożarów Mazowiecki (hereinafter: "Ordering Party" ") Under the project""1.7 - 2.6 µm InGaAs sensors development with integrated ASIC" under the Intelligent Development Operational Program 2014 - 2020 co-financed by the European Development Fund Regional request for funding number: POIR.01.01.01-00-0480/20 of 29 May 2020 concluded with the National Center for Research and Development.

- in accordance with the terms of the Order contained in the Inquiry and its attachments.

1. **Total price offered for the Subject of the Contract**
   1. Net Price: [………………………•] (in words: [………………………•]).
   2. Gross Price: [………………………•] (in words: [………………………•]).
   3. Value Added Tax: [………………………•] (in words: [………………………•]).

**Acceptance table (fill yes/no):**

|  |  |  |  |  |
| --- | --- | --- | --- | --- |
| Product name | | Parametrer | Specification | Fill Yes/no |
| **2” InP Semi Insulating**  **Doped with Fe** | Diameter 2”  Thickness: 350±25 µm  Diameter: (50.0 to 50.8)±(0.3 to 0.5mm) | Grade: | Prime, Epi-ready |  |
| Orientation: | (100)±0.3o |  |
| Primary Flat: | EJ (0-1-1) ±(0.5o do 1o) |  |
| Secondary Flat | EJ (0-11) ±(0.5o do 2o) |  |
| Resistivity: | >1E7 ohm cm |  |
| EPD (Average): | ≤5 000/cm2 max |  |
| Surface Finish: | SSP (single side polished)  Side 1: Polished  Side 2: Etched |  |
| Packaging: | ePAK, individual box, sealed with N2 in a moisture-stopping metallic foil bag, done in class 100 clean room. |  |
| Product name | | Parametrer | Specification |  |
| **4” InP Semi Insulating**  **Doped with Fe** | Diameter 4”  Thickness: 625±25 µm  Diameter: 100±0.4 mm | Grade: | Prime, Epi-ready |  |
| Orientation: | (100)±0.3o |  |
| Primary Flat: | EJ (0-1-1) ±(0.5o do 1o) |  |
| Secondary Flat | EJ (0-11) ±(0.5o do 2o) |  |
| Resistivity: | >1E7 ohm cm |  |
| EPD (Average): | ≤10 000/cm2 max |  |
| Surface Finish: | DSP (double side polished)  Side 1: Polished  Side 2: polished |  |
| Packaging: | ePAK, individual box, sealed with N2 in a moisture-stopping metallic foil bag, done in class 100 clean room. |  |
| Product name | | Parametrer | Specification |  |
| **3” InP N-type**  **Doped with S** | Diameter 3”  Thickness: (600 to 625)±25 µm  Diameter: 76.2±(0.3 do 0.4mm) | Grade: | Prime, Epi-ready |  |
| Orientation: | (100)±0.3o |  |
| Primary Flat: | EJ (0-1-1) ±(0.5o do 1o) |  |
| Secondary Flat | EJ (0-11) ±(0.5o do 2o) |  |
| Carrier Conc.: | ≥ 1E18/cm3 |  |
| EPD (Average): | ≤5000/cm2 max |  |
| Surface Finish: | DSP (Double side polished)  Side 1: Polished  Side 2: Polished |  |
| Packaging: | ePAK, individual box, sealed with N2 in a moisture-stopping metallic foil bag, done in class 100 clean room. |  |

1. **Proposal Validity Period**
   1. The validity period of the proposal is 30 days from the final date of the time limit for the proposal submission, as defined in the Request for Proposals.
2. **Contractor’s Contact Person**
   1. [………………………•], telephone number [………………………•], e-mail [………………………•].
3. **Contractor’s Declaration**
   1. The Contractor declares having read the Request for Proposals, particularly the terms and conditions of the Contract performance, contract, and does not raise any objections and also confirms the receipt of all the information necessary to prepare the following proposal and to perform the Contract.
   2. If the following proposal is considered to be the most favorable one, the Contractor undertakes to sign the contract with the Ordering Party at the time and in the place indicated by the Ordering Party.
   3. The Contractor agrees to perform the Contract described in the Request for Proposals in accordance with the requirements included in the Request for Proposals and with mandatory provisions of law and acting with due diligence.
   4. The Contractor declares as follows:
      1. the offered product completely complies with the specification included in the description of the subject of the contract;
      2. the product will be delivered in terms required in Request of Proposals
   5. Documents attached to this proposal constitute an integral part hereof.

**Contractor’s Signature**

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Attachments:

1. Extract from the Economic Operator's National Court Register / Extract from the Economic Operator's CEIDG / other registration document appropriate for the Contractor coming from the registration authority indicating the persons authorized to represent the Contractor.
2. Power of attorney (if the offer is submitted by an attorney-in-fact) Appendix No. 6 to the request for proposal;
3. Contractor's declaration on meeting the conditions for participation in the procedure Appendix 3 to the request for proposal;
4. The Contractor's declaration on the lack of connections – Appendix No. 4 to the request for proposal;
5. Description of the offered product;
6. GDPR statement – Appendix No. 7 to the inquiry.